Amendments to the Claims:

The following listing of claims will replace all prior versions, and listings, of claims in the application:

- 1. (Original) An internal electrode paste, comprising electrode material powder, a binder resin containing a polyvinyl butyral resin and/or a polyvinyl acetal resin as the main component, and a solvent.
- 2. (Original) The internal electrode paste as set forth in claim 1, furthermore comprising a plasticizer, wherein said plasticizer is contained by 25 parts by weight or more and 150 parts by weight or less with respect to 100 parts by weight of said binder resin.
- 3. (Currently Amended) The internal electrode paste as set forth in claim 1-or 2, wherein said binder resin is contained by 2.5 to 5.5 parts by weight with respect to 100 parts by weight of said electrode material powder.
- 4. (Currently Amended) The internal electrode paste as set forth in <u>claim 1</u> any one of claims 1 to 3, furthermore comprising ceramic powder.
- 5. (Original) The internal electrode paste as set forth in claim 4, wherein said binder resin is contained by 2.5 to 5.5 parts by weight with respect to a total of 100 parts by weight of said electrode material powder and ceramic powder.
- 6. (Currently Amended) The internal electrode paste as set forth in <u>claim 1-any</u> one of claims 1 to 5, wherein said electrode material powder is contained by 50 wt% or less with respect to the entire internal electrode paste.
- 7. (Currently Amended) The internal electrode paste as set forth in <u>claim 1</u>-any one of claims 1 to 6, wherein a polymerization degree of said polyvinyl butyral resin and/or a polyvinyl acetal resin is 1400 or more and 3600 or less.
- 8. (Currently Amended) The internal electrode paste as set forth in <u>claim 1</u> any one of claims 1 to 7, wherein an acetalization degree of said polyvinyl acetal resin is 74 mol% or less.

9. (Currently Amended) A production method of an electronic device, comprising the steps of:

preparing the internal electrode paste as set forth in <u>claim 1</u> any one of claims 1 to 8; forming a green sheet;

forming an internal electrode layer by using said internal electrode layer paste; stacking said green sheets via internal electrode layers to obtain a green chip; and firing said green chip.

10. (Currently Amended) A production method of an electronic device, comprising the steps of:

forming an electrode layer on a surface of a first supporting sheet by using the internal electrode paste as set forth in claim 1 any one of claims 1 to 8,;

pressing said electrode layer against a surface of a green sheet and adhering said electrode layer to the surface of said green sheet;

stacking the green sheet adhered with said electrode layer to form a green chip; and firing said green chip.